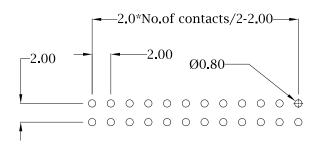
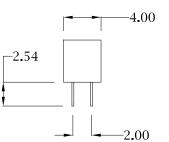


04~20 pin: 0.10mm 22~50 pin: 0.20mm 52~80 pin: 0.30mm

Recommended P.C. Board Hole Layout





Material:

Insulator: Nylon-6T, Black, UL 94V-O Process Temperature: 260°C for 10 seconds Contact: Phosphor Bronze Gold Flash Mating Side

 100μ " Tin on Board Side

Electrical:

Current Rating: 2 Amps Contact Resistance: 20 mOhms Max. Insulation Resistance: 5000 MOhms Min.

Working Voltage: 250V

Temperature: -40° C TO +105° C

2564YY01RP2

Series 2564 = Dual Row **Position** Dual - Increments of 2 (04 to 80) **Type** 01 = Straight **Plating Options**

P2 = Gold Flash Mating Side, 100μ " Tin on Board Side

Units = mm

Tolerance ± 0.3 ±0.20 .XX XXX ±0.100 THESE DRAWINGS AND SPECIFICATIONS

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DRAWN: DATE: PAM JENKINS 1-30-06 SCALE: NTS 3

DWG NO. 2564YY01RP2

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